Texas Instruments Inc. (DUNS# 00-732-1904) Supplier Name:

Contact Info:

ti.com/support
Distribute - RoHS and IEC 62474 DB Form/Declaration Type:

Created on: 06/13/2022

Details for "UCC28086DR"

Current Product Information

TI part number	Lead finish/Ball material	MSL rating/peak reflow	Assembly site	Package Pins	Package body size (mm)	Total device mass (mg)*
UCC28086DR	NIPDAU	Level-1-260C-UNLIM	TI AGUASCALIENTES	D 8	3.91x4.9x1.58	84.7

*Total Device Mass

The summary mass is a rounded value and will be within approximately +/- 10% of the detailed mass value.

Environmental Ratings Information

RoHS	REACH	Green	IEC 62474 DB
Yes	Yes	Yes	Yes

Component Information

				Homogeneous Material Level		Component Level	
Component	Substance	CAS Number	Amount (mg)	Percentage %	ppm	Percentage %	ppm
Bond Wire							
Copper and Its Alloys	Copper	7440-50-8	0.055485	99.998198	999982	0.065545	655
Precious Metals	Silver	7440-22-4	0.000001	0.001802	18	0.000001	0
Sub-Total			0.055486	100	1000000	0.065546	655
Die Attach Adhesive							
Precious Metals	Silver	7440-22-4	0.661655	78.999998	790000	0.781616	7816
Thermoplastics	Ероху	85954-11-6	0.175883	21.000002	210000	0.207771	2078
Sub-Total			0.837538	100	1000000	0.989387	9894
Lead Frame							
Copper and Its Alloys	Copper	7440-50-8	24.025981	97.425003	974250	28.382	283820
Copper and Its Alloys	Iron	7439-89-6	0.591864	2.4	24000	0.699172	6992
Copper and Its Alloys	Phosphorus	7723-14-0	0.003699	0.014999	150	0.00437	44
Copper and Its Alloys	Tin	7440-31-5	0.007398	0.029999	300	0.008739	87
Copper and Its Alloys	Zinc	7440-66-6	0.024661	0.1	1000	0.029132	291
Other Nonferrous Metals and Alloys	Lead	7439-92-1	0.007398	0.029999	300	0.008739	87
Sub-Total			24.661001	100	1000000	29.132152	291322
Lead Frame Plating							
Nickel and Its Alloys	Nickel	7440-02-0	0.037097	95.120513	951205	0.043823	438
Precious Metals	Gold	7440-57-5	0.000304	0.779487	7795	0.000359	4
Precious Metals	Palladium	7440-05-3	0.001599	4.1	41000	0.001889	19
Sub-Total			0.039	100	1000000	0.046071	461
Mold Compound							
Other Inorganic Materials	Fused Silica	60676-86-0	49.291826	88.000001	880000	58.228657	582287
Other Plastics and Rubber	Carbon Black	1333-86-4	0.16804	0.299999	3000	0.198506	1985
Other Plastics and Rubber	Organic Phosphorus	1330-78-5	0.308074	0.55	5500	0.363929	3639
Thermoplastics	Ероху	85954-11-6	6.245498	11.149999	111500	7.377835	73778
Sub-Total			56.013438	100	1000000	66.168928	661689
Semiconductor Device	•			•		•	
Ceramics / Glass	Doped Silicon	7440-21-3	3.045714	100	1000000	3.597916	35979
Sub-Total			3.045714	100	1000000	3.597916	35979
Total			84.652177	•		100	1000000

The ppm calculations are at the homogeneous material level and are maximum concentration values. The ppm displayed represents the homogeneous material with the highest ppm

for that substance. The amount (mg) calculations represent the maximum total amount of each substance within the component.

The ppm calculations are at the component level and are average concentration values. The amount (mg) calculations represent the average total amount of each substance within the component.

See Glossary of Terms for more details.

Important Part Information

There is a remote possibility the Customer Part Number (CPN) your company uses could reference more than one TI part number. This is due to two or more users (EMSIs or subcontractors) using the same CPN for different TI part numbers. If this occurs, please check your Customer Part Number and cross reference it with the TI part number seen on this page.

Product Content Methodology

 $\underline{\text{For an explanation of the methods used to determine material weights, See Product Content Methodology}}$

Material Declaration Certificate for Semiconductor IC Packaged Products

TI certifies that the material content information provided by TI is representative and accurate to the best of their knowledge based on material information provided by its suppliers and their combination into finished IC packaged products. TI semiconductor products designated to be "Pb-free", "Green" or "RoHS Exempt" fully meets the latest EU RoHS Directive requirements along with other legislation as seen in the former JIG-101 list that has been transferred to the IEC 62474 database.

TI bases its material content information on information provided by third-party suppliers and has taken, and continues to take, reasonably diligent steps to provide any required or available information. TI may not have conducted destructive testing or chemical analysis on incoming materials and chemicals. TI and TI suppliers may consider certain information to be proprietary, and thus certain information may not be available for release by TI. The material content information is provided by TI "as is." For additional information, please contact TI customer support.

Signature: (click here for a fuller statement with a signed certificate)

Name/Title: Hubie Payne, Vice President, Worldwide SC Quality For further environmental statements, please go to www.ti.com/ecoinfo Created on: 06/13/2022

ROHS: Means TI semiconductor products that are compliant with the current ROHS requirement that the maximum concentration values of the ten substances listed in ROHS Annex II do not exceed 0.1 % by weight in homogeneous materials. Where designed to be soldered at high temperatures, Ti semiconductor products labeled as "RoHS Compliant" are suitable for use in specified lead-free processes. Ti may also reference these types of semiconductor products as "Pb-Free." These Ti semiconductor products are also fully compliant with GADSL and the IEC 62474 database for electronic requirements.

ROHS Exempt: Means TI semiconductor products that contain lead (Pb) above the RoHS Annex II threshold, but that fall within one of the specific RoHS exemptions noted above or documented in http://www.ti.com/lit/pdf/szzq088

Green: Means the content of Chlorine (CI) and Bromine (Br)-based flame retardants meet IS709B low halogen requirements of <=1 000ppm threshold; Antimony trioxide (Sb203) contained in halogen based flame retardant materials meets the <=1 000ppm threshold requirement; and Beryllium Oxide (BeO) is <=1000ppm.